

Part Number : <u>15453510</u>

Product Description : 2.54mm Pitch C-Grid PCB Connector, Surface Mount, High Profile, Dual Row,

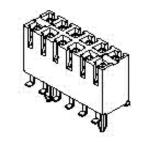
Vertical, 10 Circuits

Series Number: 71395

Status: Active

Product Category: PCB Headers and Receptacles

Engineering Number: A713950110



Documents & Resources

Drawings

015453510 sd.pdf

PK-70873-0662-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

AS-71395-001-001.pdf

PS-71395-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	⊚ per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	71395
Description	2.54mm Pitch C-Grid PCB Connector, Surface Mount, High Profile, Dual Row, Vertical, 10 Circuits
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	C-Grid
UPC	800754240574

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	2.5A
Grounding to PCB	No
Voltage - Maximum	250V AC (RMS)

Physical

Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	50
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.848/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	REFLOW
Max-Cycle	1

Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid Vertical, Dual Row, Low Profile Headers	<u>70246</u>
C-Grid Vertical, Dual Row, Through Hole Headers without Peg	<u>70567</u>
C-Grid Right-Angle, Dual Row, Low Profile Headers	<u>70247</u>
C-Grid Right-Angle, Dual Row, Through Hole Headers	<u>74162</u>
C-Grid Vertical Dual Row Breakaway Headers	<u>70280</u>
C-Grid Vertical Dual Row Breakaway Headers with Retention Pin	<u>70287</u>
C-Grid Vertical, Dual Row, Surface Mount Breakaway Headers	<u>71308</u>
C-Grid Right-Angle Dual Row Breakaway Headers	<u>70216</u>
C-Grid Right-Angle, Dual Row, Low Profile, Breakaway Headers	<u>71764</u>

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